(Unit: mm)

PQ1Uxx1M2ZP Series

Low Output Current, Compact Surface Mount Type Low Power-Loss Voltage Regulators

Features

- Compact surface mount package (2.9×1.6×1.1mm)
- Low power-loss (Dropout voltage: TYP. 0.11 V at Io=60mA)
- High ripple rejection (TYP. 70dB)
- Built-in ON/OFF control function (Dissipation current at OFF-state: MAX. 1μA)
- Built-in overcurrent, overheat protection functions
- *It is available for every 0.1V of output voltage (1.3V to 5.0V)

Applications

- Cellular phones
- Cordless phones
- Personal information tools (PDA)
- Cameras/Camcoders
- PCMCIA cards for notebook PCs

■ Model Line-up

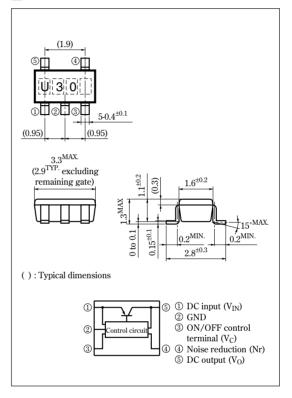
Output Voltage (TYP.)	Model No.	Output Voltage (TYP.)	Model No.
2.5V	PQ1U251M2ZP	3.5V	PQ1U351M2ZP
2.8V	PQ1U281M2ZP	3.6V	PQ1U361M2ZP
3.0V	PQ1U301M2ZP	3.8V	PQ1U381M2ZP
3.3V	PQ1U331M2ZP	4.0V	PQ1U401M2ZP
3.4V	PQ1U341M2ZP	5.0V	PQ1U501M2ZP

■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
*1Input voltage	$V_{\rm IN}$	16	V
*1 ON/OFF control terminal voltage	Vc	16	V
Output current	Io	300	mA
*2Power dissipation	PD	350	mW
*3 Junction temperature	Tj	150	°C
Operating temperature	Topr	-30 to +80	°C
Storage temperature	Tstg	-55 to +150	°C
Soldering temperature	Tsol	260 (10s)	°C

^{*1} All are open except GND and applicable terminals.

Outline Dimensions



SHADD

^{*}2 At mounted on PCB

^{#3} Overheat protection may operate at T_j=125°C to 150°C

[·] Please refer to the chapter " Handling Precautions ".

Electrical Characteristics

(Unless otherwise specified, V_{IN}=V₀(TYP)+1.0V, I₀=30mA, V_c=1.8V, T_a=25°C)

Parameter	Symbol	Conditions	MIN. TYP. MAX.		Unit	
Output voltage	Vo	=	Refer to the following table.1		V	
**4Output peak current	Iop	_	180 300 -		mA	
Recommended output current	_	_	150		mA	
	RegL1	Io=5 to 60mA		10	50	mV
Load regulation	RegL2	Io=5 to 100mA		20	100	mV
	RegL3	Io=5 to 150mA	_	30	160	mV
Line regulation	RegI	V _{IN} =V _O (TYP)+1V to V _O (TYP)+6V	- 3.0 20		mV	
Temperature coefficient of output voltage	TcVo	Io=10mA, T _j =-25 to +75°C	- 0.05 -		mV/°C	
Ripple rejection	RR	Refer to Fig.2	- 70 -		dB	
Output noise voltage	V _{no (rms)}	10Hz <f<100khz, c<sub="">n=0.1μF, Io=30mA</f<100khz,>	Refer to the following table.2		μV	
Description	V _{I-O} 1	Io=60mA *5 - 0.11		0.26	v	
Dropout voltage	V _{I-O} 2	Io=150mA*5	_	0.20	0.4	\ \ \
*6ON-state voltage for control	V _C (ON)	_	1.8 – –		V	
ON-state current for control	Ic (on)	Vc=1.8V - 5 30		30	μΑ	
OFF-state voltage for control	V _C (OFF)	0.4		0.4	V	
Quiescent current	Iq	Io=0mA	- 130 200		μA	
Output OFF-state dissipation current	Iqs	Vc=0.2V	Vc=0.2V - 1		1	μΑ

^{#4} Output current shall be the value when output voltage lowers 0.3V from the voltage at Io=30mA.

Table.1 Output Voltage Line-up

(V_{IN}=V_O(TYP)+1.0V, I_O=30mA, V_C=1.8V, Ta=25°C)

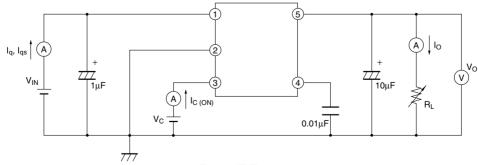
Model No.	Symbol	MIN.	TYP.	MAX.	Unit
PQ1U181M2ZP		1.740	1.8	1.860	
PQ1U251M2ZP		2.440	2.5	2.560	
PQ1U281M2ZP		2.740	2.8	2.860	
PQ1U291M2ZP		2.840	2.9	2.960	
PQ1U301M2ZP	Vo	2.940	3.0	3.060	
PQ1U331M2ZP		3.234	3.3	3.366	V
PQ1U341M2ZP		3.332	3.4	3.468	v
PQ1U351M2ZP		3.430	3.5	3.570	
PQ1U361M2ZP		3.528	3.6	3.672	
PQ1U381M2ZP		3.724	3.8	3.876	
PQ1U401M2ZP		3.920	4.0	4.080	
PQ1U501M2ZP		4.900	5.0	5.100	

Table.2 Output Noise Voltage Line-up

 $(V_{IN}=V_O(TYP)+1.0V, I_O=30mA, V_C=1.8V, C_n=0.1\mu F, 10Hz < f < 100kHz, Ta=25°C)$

Model No.	Symbol	MIN.	TYP.	MAX.	Unit
PQ1U181M2ZP		_	15	_	
PQ1U251M2ZP		_	25	_	
PQ1U281M2ZP		-	25	-	
PQ1U291M2ZP		-	25	_	
PQ1U301M2ZP	Vno(rms)	-	30	_	
PQ1U331M2ZP		_	30	_	
PQ1U341M2ZP		_	30	-	μV
PQ1U351M2ZP		-	35	_	
PQ1U361M2ZP		-	35	_	
PQ1U381M2ZP		_	35	-	
PQ1U401M2ZP		_	40	_	
PQ1U501M2ZP		_	50	_	

Fig.1 Test Circuit



^{*5} Input voltage when output voltage falls 0.1V from that at Vin=Vo(TYP)+1.0V.

^{#6} In case of **PQ1U181M2ZP**, V_{IV} minimum=2.3V.

Fig.2 Test Circuit for Ripple Rejection

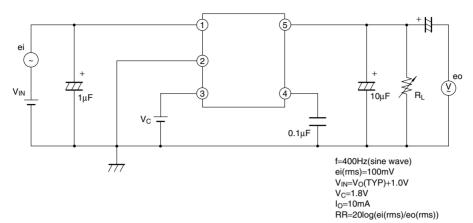
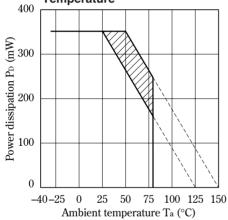


Fig.3 Power Dissipation vs. Ambient Temperature



Note) Oblique line portion: Overheat protection may operate in this area.

Fig.5 Output Voltage Fluctuation vs. Junction Temperature (PQ1U281M2ZP)(Typical Value)

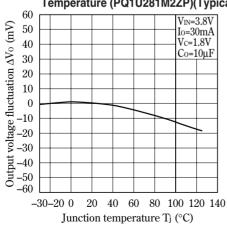


Fig.4 Overcurrent Protection Characteristics (Typical Value)

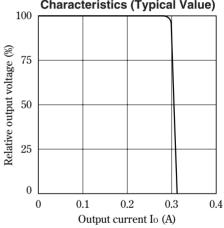


Fig.6 Output Voltage vs. Input Voltage (PQ1U281M2ZP)(Typical Value)

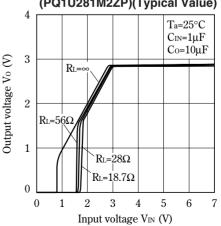


Fig.7 Circuit Operating Current vs. Input Voltage Fig.8 (PQ1U281M2ZP)(Typical Value)

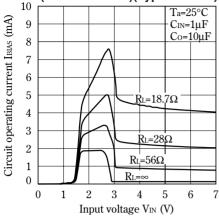


Fig.9 Quiescent Current vs. Junction Temperature (Typical Value)

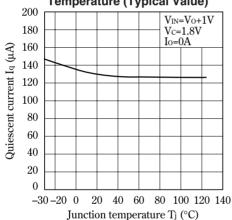
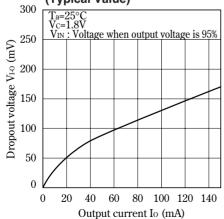


Fig.11 Dropout Voltage vs. Output Current (Typical Value)



Dropout Voltage vs. Junction Temperature (PQ1U281M2ZP)(Typical Value)

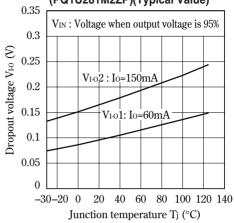
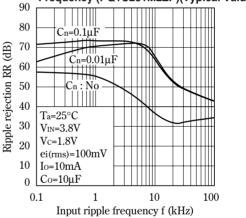


Fig.10 Ripple Rejection vs. Input Ripple Frequency (PQ1U281M2ZP)(Typical Value)



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